

## **Ph.D. DISSERTATION DEFENSE**

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**Degree:** Doctor of Philosophy  
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**Title:** Manufacturing and Thermal Transport Properties of  
Flexible Two-Dimensional Materials

**Chairperson:** Dr. Annie Zhang, Department of Mechanical Engineering, School of  
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## **ABSTRACT**

This dissertation presents a comprehensive investigation into the thermal transport properties of two-dimensional (2D) materials, with a focus on how strain engineering can modulate phonon and electron transport. A combination of experimental fabrication, advanced characterization, and first-principles simulations was employed to uncover the underlying mechanisms governing heat and charge conduction in low-dimensional systems.

The synthesis and transfer of high-quality monolayer and bilayer samples of various 2D materials, including graphene, MoS<sub>2</sub>, Fe-MoS<sub>2</sub>, were achieved by mechanical exfoliation, chemical vapor deposition, and wet transfer. In addition, a laser-based method was proposed to fabricate nanoscale structures with controlled morphology, offering new opportunities for energy-related and emerging quantum technologies.

The influence of tensile strain on thermal conductivity was systematically explored. Strain was found to alter both lattice geometry and defect distributions, leading to enhanced phonon scattering and reduced thermal transport. Bilayer structures, serpentine structure, elemental doping, and heterostructure formation were shown to be effective in mitigating strain-induced degradation, providing useful design principles for stabilizing heat conduction under mechanical deformation.

This work contributes to the fundamental understanding of thermal transport in 2D materials. It demonstrates that mechanical, chemical, and structural modifications can be strategically employed to tailor transport properties, offering practical guidelines for the design of next-generation materials in nanoelectronics, thermal management, and energy conversion applications.